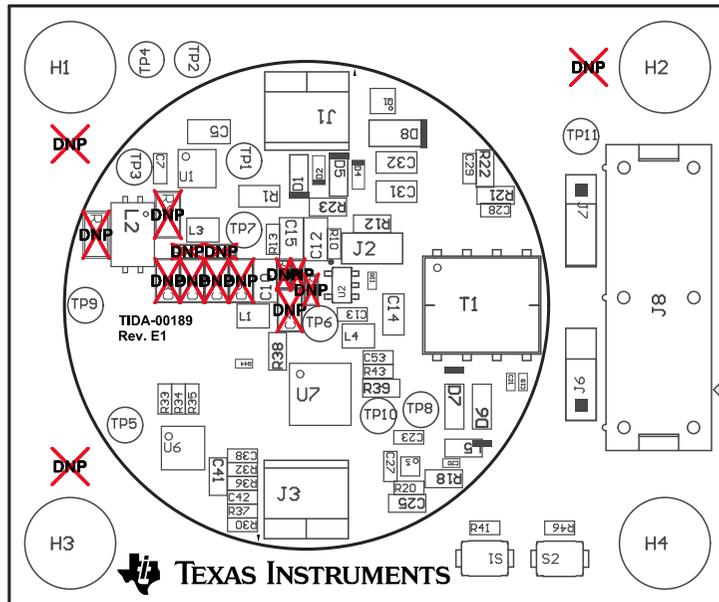


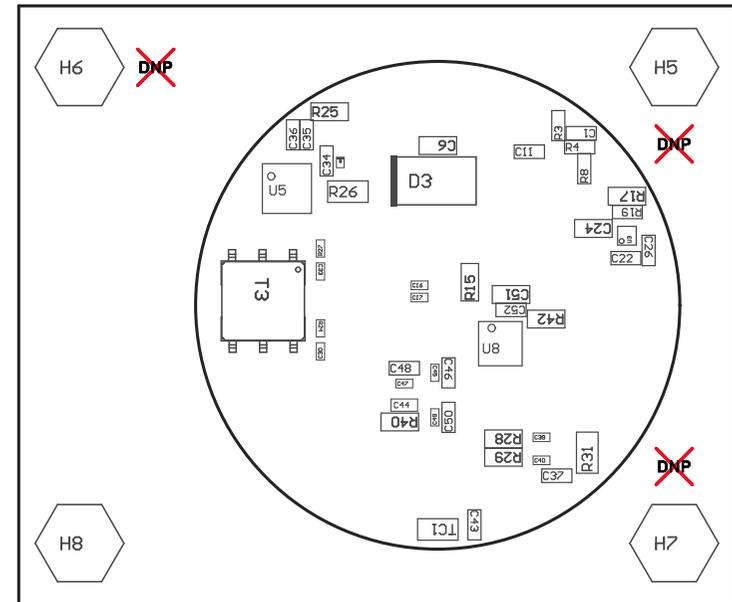
Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

Z22 ■ This Assembly Note will show in the PcbDoc and associated outputs

Z23 ■ This Assembly Note will show in the PcbDoc and associated outputs

Z24 ■ This Assembly Note will show in the PcbDoc and associated outputs





COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: TIDA-00189_E2

| | | | |
|-------------------------------------|-----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: TIDA-00189 | REV: E1 | SUN REV: Not In VersionControl |
| | IGNORE -> Bottom Overlay | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 9/19/2014 10:29:39 AM | TEXAS INSTRUMENTS | |

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